

DMS3014SFG

Marking Information



S29 = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 18 = 2018) WW = Week Code (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			V _{DSS}	30	V
Gate-Source Voltage			V _{GSS}	±12	V
Continuous Drain Current (Note 6) V _{GS} = 10V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	I _D	9.5 7.6	А
	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	13.0 9.7	А
Continuous Dunin Courset (Note C) // 45/	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	l _D	9.0 7.4	А
Continuous Drain Current (Note 6) V _{GS} = 4.5V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	12.2 9.3	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	Ірм	80	А		
Maximum Continuous Body Diode Forward Current (Note 6)			Is	3.0	А
Avalanche Current (Note 7) L = 0.1mH		I _{AR}	30	А	
Repetitive Avalanche Energy (Note 7) L = 0.1mH			EAR	45	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

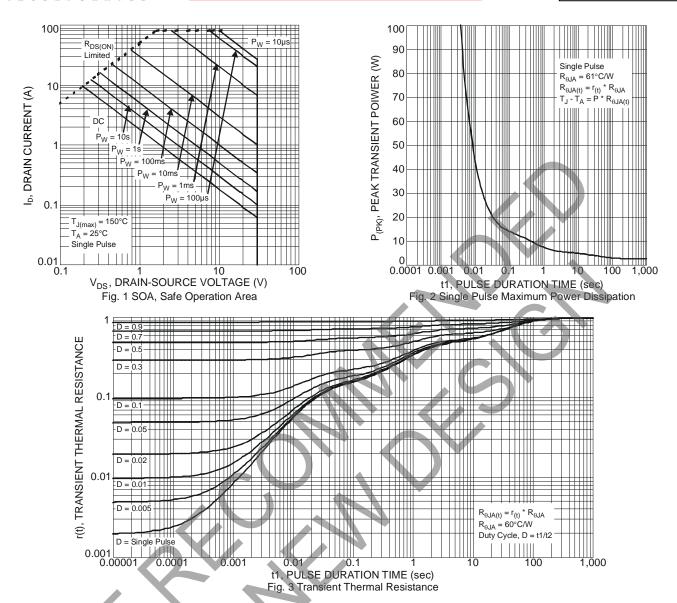
Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		P_{D}	1	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{ hetaJA}$	131	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t<10s		72	°C/W
Total Power Dissipation (Note 6)		P_{D}	2.1	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{ hetaJA}$	63	°C/W
Thermal Resistance, Sunction to Ambient (Note 6)	t<10s		35	°C/W
Thermal Resistance, Junction to Case (Note 6)	$R_{ heta JC}$	7.1	°C/W	
Operating and Storage Temperature Range	$T_{J_i} T_{STG}$	-55 to +150	°C	

Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 I_{AR} and E_{AR} ratings are based on low frequency and duty cycles to keep T_J = +25°C.







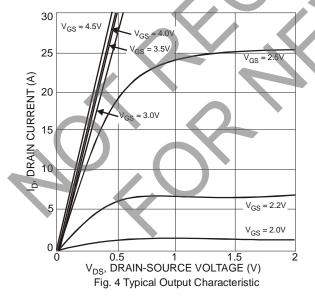


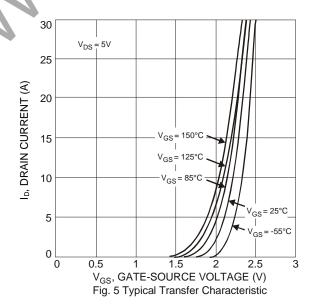


Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	I _{DSS}	_	_	100	μΑ	$V_{DS} = 30V$, $V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(TH)}	1.0	_	2.2	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
Static Drain-Source On-Resistance	D	_	9	13	mΩ	$V_{GS} = 10V, I_D = 10.4A$
Static Drain-Source On-Resistance	R _{DS(ON)}	_	10	14		$V_{GS} = 4.5V$, $I_D = 10.4A$
Forward Transfer Admittance	Y _{fs}	_	23	_	S	$V_{DS} = 5V, I_{D} = 10.4A$
Diode Forward Voltage	V _{SD}	_	0.4	0.55	V	$V_{GS} = 0V$, $I_{S} = 1A$
DYNAMIC CHARACTERISTICS (Note 9)						A
Input Capacitance	C _{iss}	_	2296	4310	pF	
Output Capacitance	Coss	_	164	_	pF	$V_{DS} = 15V, V_{GS} = 0V,$ $f = 1.0MHz$
Reverse Transfer Capacitance	C _{rss}	_	120		pF	1 - 1 . OIVII 12
Gate Resistance	R_{g}	0.26	1.3	2.34	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge V _{GS} = 4.5V	Q_g	_	19.3	_	nC	
Total Gate Charge V _{GS} = 10V	Qg	_	45.7	-	nC	V 15V V 10V I 10 10
Gate-Source Charge	Q _{gs}	_	5.0	_	nC	$V_{DS} = 15V$, $V_{GS} = 10V$, $I_D = 10.4A$
Gate-Drain Charge	Q_{gd}		2.9		nC	
Turn-On Delay Time	t _{D(ON)}		5.5	/ –	ns	
Turn-On Rise Time	t _R	-//	24.4	_	ns	$V_{GS} = 10V, V_{DS} = 15V,$
Turn-Off Delay Time	t _{D(OFF)}	D-1	33.1		ns	$R_G = 3\Omega$, $R_L = 1.2\Omega$
Turn-Off Fall Time	t _F	1-1	6.6	7-	ns	▼
Reverse Recovery Time	t _{RR}		12.9	/ -,	ns	I _F = 13A, di/dt = 500A/µs
Reverse Recovery Charge	Q _{RR}		8.0		nC	I _F = 13A, di/dt = 500A/μs

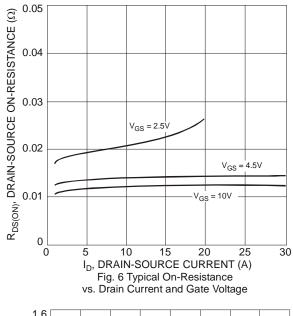
Notes: 8. Short duration pulse test used to minimize self-heating effect.

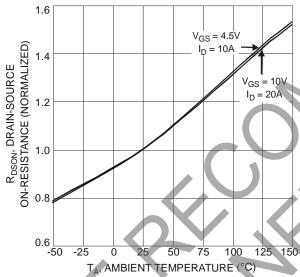




^{9.} Guaranteed by design. Not subject to product testing.







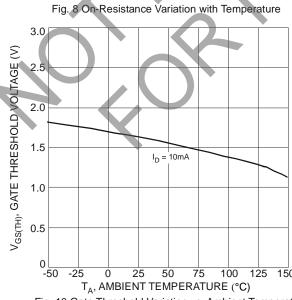
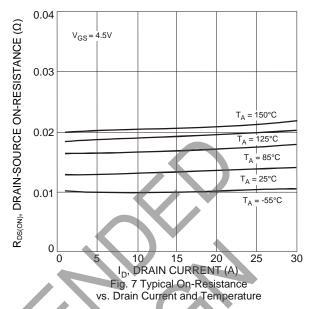


Fig. 10 Gate Threshold Variation vs. Ambient Temperature



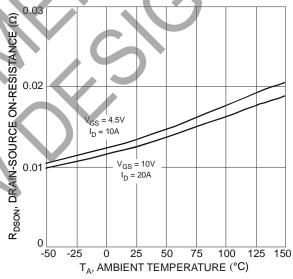


Fig. 9 On-Resistance Variation with Temperature

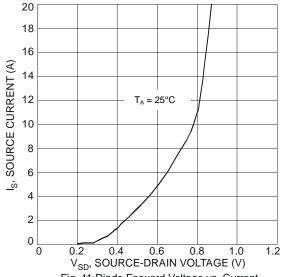
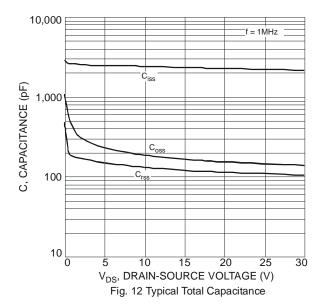


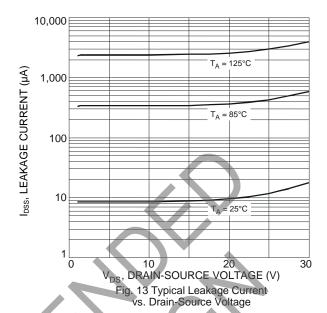
Fig. 11 Diode Forward Voltage vs. Current

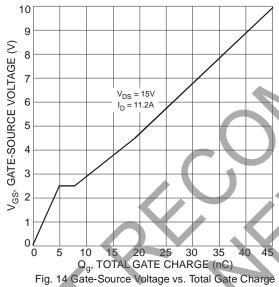


NOT RECOMMENDED FOR NEW DESIGN -NO ALTERNATE PART

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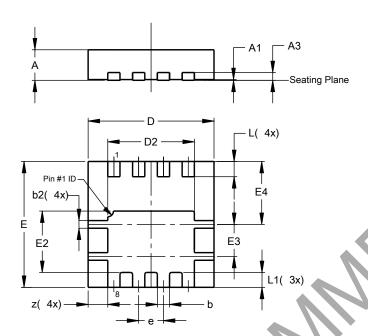




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8

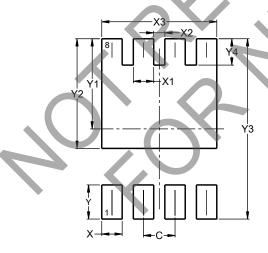


PowerDI3333-8					
Dim	Min	Max	Тур		
A	0.75	0.85	0.80		
A1	0.00	0.05	0.02		
A3	_		0.203		
b	0.27	0.37	0.32		
b2	0.15	0.25	0.20		
Ь	3.25	3.35	3.30		
D2	2.22	2.32	2.27		
П	3.25	3.35	3.30		
E2	1.56	1.66	1.61		
E3	0.79	0.89	0.84		
E4	1.60	1.70	1.65		
e	-6	=	0.65		
7	0.35	0.45	0.40		
L1		_	0.39		
Z	_	_	0.515		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8



Dimensions	Value (in mm)
C	0.650
Х	0.420
X1	0.420
X2	0.230
Х3	2.370
Ý	0.700
Y1	1.850
Y2	2.250
Y3	3.700
Y4	0.540



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